International Workshop on Radiation Imaging Detectors iWoRID 2011

Monday, 4 July 2011

Sensor Materials, Device Processing & Technologies II: 2 contributions - HG E7 (16:25 - 17:40)

-Conveners: Val O'Shea

time [id] title		presenter
16:25 [9] Wafer Level 3D	Integration Technologies	FRITZSCH, Thomas
17:00 [126] Cadmium Tel imaging device	lluride pixel sensor development for high sensibility X-r	ay Dr TOYOKAWA, Hidenori
17:20 [120] CdTe Medipix Technology and De	x2 and Medipix3 Pixel Detectors: Material Characteriza evice Performance	ation, Dr FIEDERLE, Michael